

Silizium-Fotodiode

Silicon Photodiode

BPW 33



Wesentliche Merkmale

- Speziell geeignet für Anwendungen im Bereich von 350 nm bis 1100 nm
- Sperrstromarm (typ. 20 pA)
- DIL-Plastikbauform mit hoher Packungsdichte

Anwendungen

- Belichtungsmesser
- Farbanalyse

Features

- Especially suitable for applications from 350 nm to 1100 nm
- Low reverse current (typ. 20 pA)
- DIL plastic package with high packing density

Applications

- Exposure meters
- Color analysis

Typ Type	Bestellnummer Ordering Code
BPW 33	Q62702-P76

Grenzwerte**Maximum Ratings**

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Betriebs- und Lagertemperatur Operating and storage temperature range	$T_{op}; T_{stg}$	- 40 ... + 85	°C
Sperrspannung Reverse voltage	V_R	7	V
Verlustleistung, $T_A = 25$ °C Total power dissipation	P_{tot}	150	mW

Kennwerte ($T_A = 25$ °C, Normlicht A, $T = 2856$ K)**Characteristics ($T_A = 25$ °C, standard light A, $T = 2856$ K)**

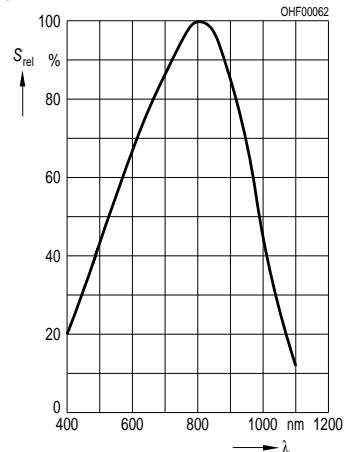
Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Fotoempfindlichkeit, $V_R = 5$ V Spectral sensitivity	S	75 (≥ 35)	nA/lx
Wellenlänge der max. Fotoempfindlichkeit Wavelength of max. sensitivity	$\lambda_{S_{max}}$	800	nm
Spektraler Bereich der Fotoempfindlichkeit $S = 10\%$ von S_{max} Spectral range of sensitivity $S = 10\%$ of S_{max}	λ	350 ... 1100	nm
Bestrahlungsempfindliche Fläche Radiant sensitive area	A	7.34	mm ²
Abmessung der bestrahlungsempfindlichen Fläche Dimensions of radiant sensitive area	$L \times B$ $L \times W$	2.71 × 2.71	mm × mm
Abstand Chipoberfläche zu Gehäuseoberfläche Distance chip front to case surface	H	0.5	mm
Halbwinkel Half angle	ϕ	± 60	Grad deg.
Dunkelstrom, $V_R = 1$ V Dark current	I_R	20 (≤ 100)	pA
Nullpunktsteilheit, $E = 0$ Zero crossover	S_0	≤ 2.5	pA/mV
Spektrale Fotoempfindlichkeit, $\lambda = 850$ nm Spectral sensitivity	S_λ	0.59	A/W

Kennwerte ($T_A = 25^\circ\text{C}$, Normlicht A, $T = 2856\text{ K}$)

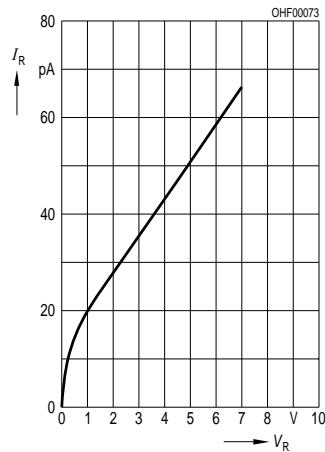
Characteristics ($T_A = 25^\circ\text{C}$, standard light A, $T = 2856\text{ K}$) (cont'd)

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Quantenausbeute, $\lambda = 850\text{ nm}$ Quantum yield	η	0.86	Electrons Photon
Leerlaufspannung, $E_v = 1000\text{ lx}$ Open-circuit voltage	V_O	440 (≥ 375)	mV
Kurzschlußstrom, $E_v = 1000\text{ lx}$ Short-circuit current	I_{SC}	72	μA
Anstiegs- und Abfallzeit des Fotostromes Rise and fall time of the photocurrent $R_L = 1\text{ k}\Omega; V_R = 5\text{ V}; \lambda = 850\text{ nm}; I_p = 70\text{ }\mu\text{A}$	t_r, t_f	1.5	μs
Durchlaßspannung, $I_F = 100\text{ mA}, E = 0$ Forward voltage	V_F	1.3	V
Kapazität, $V_R = 0\text{ V}, f = 1\text{ MHz}, E = 0$ Capacitance	C_0	630	pF
Temperaturkoeffizient von V_O Temperature coefficient of V_O	TC_V	- 2.6	mV/K
Temperaturkoeffizient von I_{SC} Temperature coefficient of I_{SC}	TC_I	0.2	%/K
Rauschäquivalente Strahlungsleistung Noise equivalent power $V_R = 1\text{ V}, \lambda = 850\text{ nm}$	NEP	4.3×10^{-15}	$\frac{\text{W}}{\sqrt{\text{Hz}}}$
Nachweisgrenze, $V_R = 1\text{ V}, \lambda = 850\text{ nm}$ Detection limit	D^*	6.3×10^{13}	$\frac{\text{cm} \times \sqrt{\text{Hz}}}{\text{W}}$

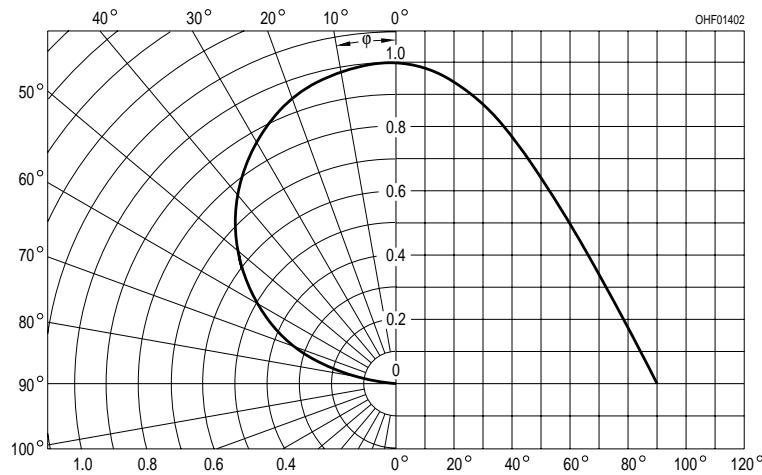
Relative Spectral Sensitivity
 $S_{\text{rel}} = f(\lambda)$



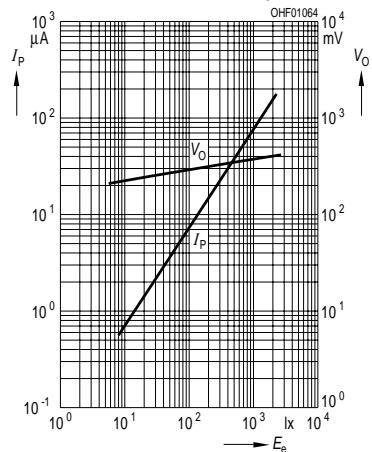
Dark Current
 $I_R = f(V_R), E = 0$



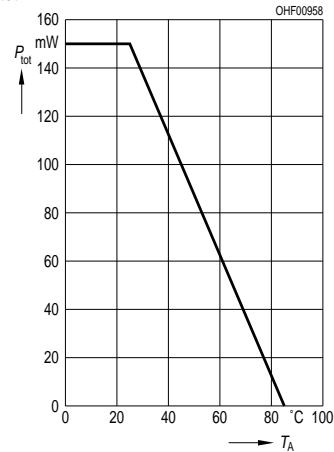
Directional Characteristics
 $S_{\text{rel}} = f(\phi)$



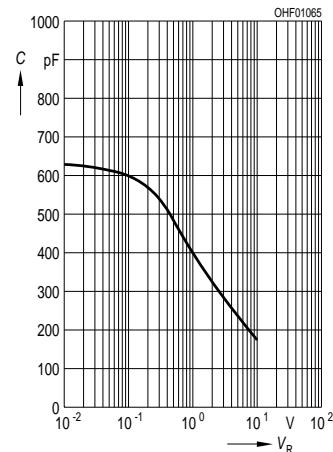
Photocurrent $I_P = f(E_v)$, $V_R = 5$ V
Open-Circuit Voltage $V_O = f(E_v)$



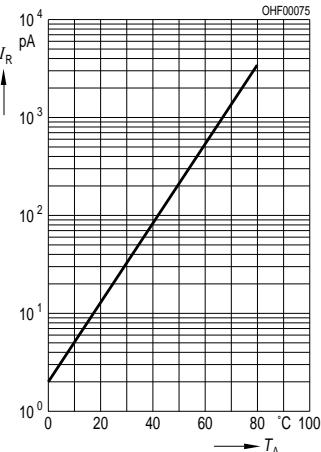
Total Power Dissipation
 $P_{\text{tot}} = f(T_A)$



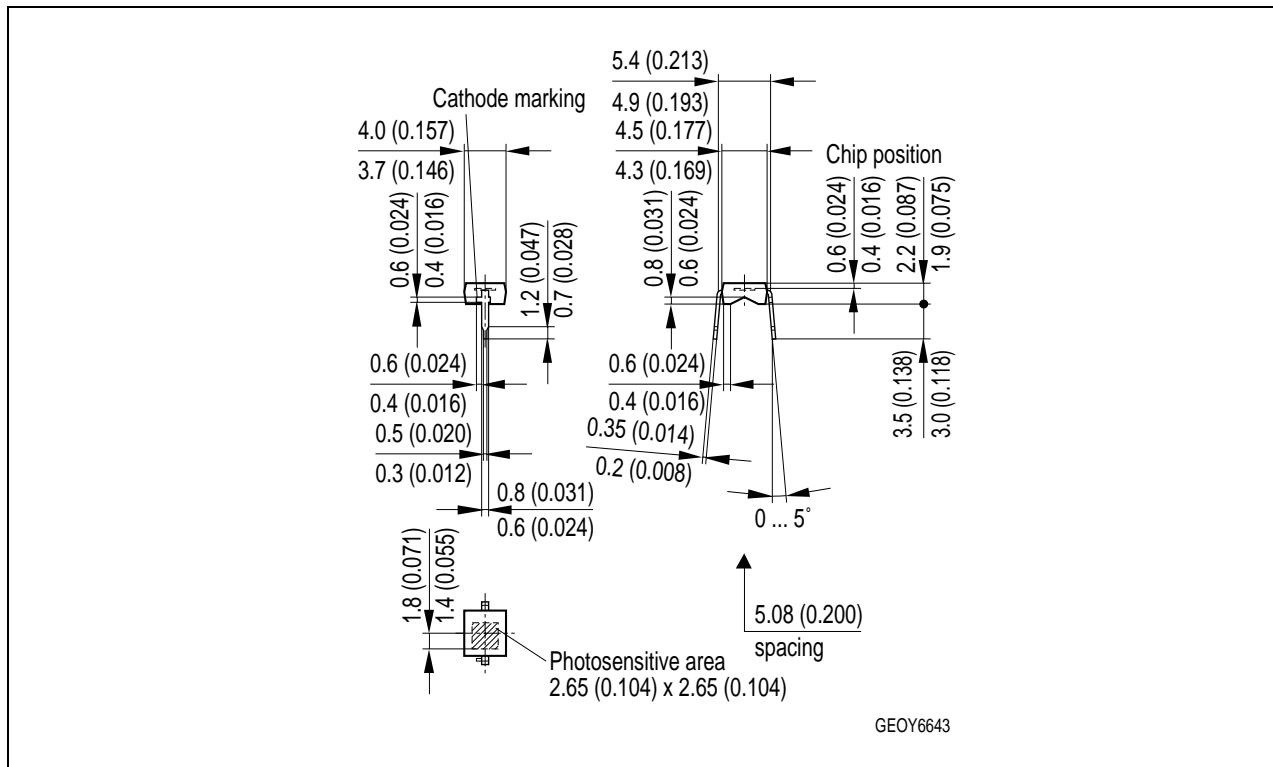
Capacitance
 $C = f(V_R), f = 1$ MHz, $E = 0$



Dark Current
 $I_R = f(T_A), V_R = 1$ V, $E = 0$



Maßzeichnung Package Outlines



Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).

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dangerous
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Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Components used in life-support devices or systems must be expressly authorized for such purpose! Critical components¹, may only be used in life-support devices or systems² with the express written approval of OSRAM OS.

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